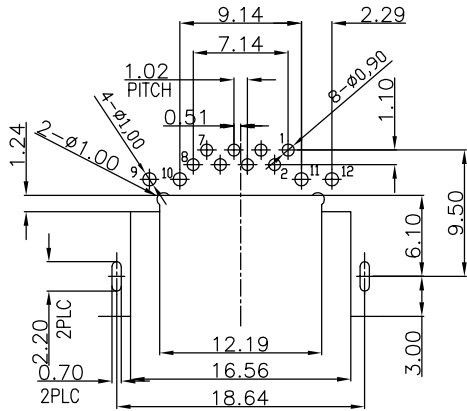
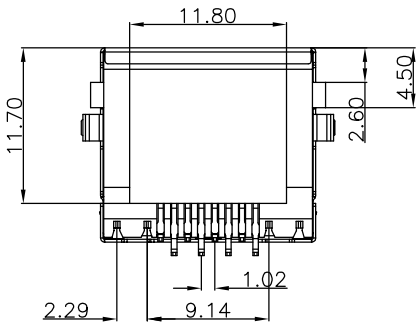
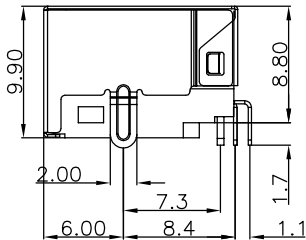
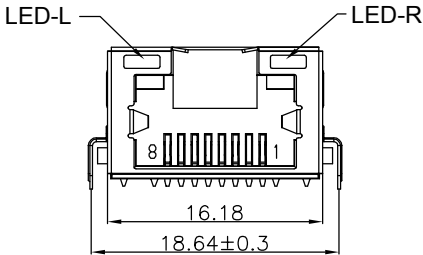
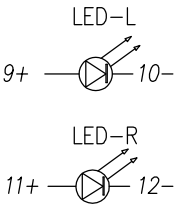
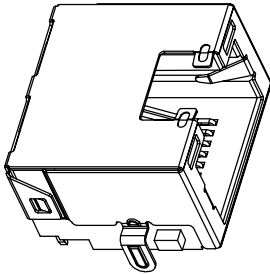
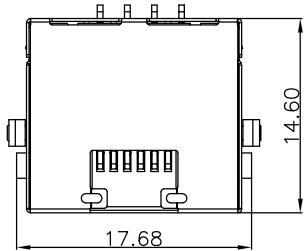


The product using material and processing must conform to the "WL-PZ-001"HSF technical standard control requirements



PCBLAYOUT
TOL:±0.05

- NOTE:
- 1.MATERIAL SPECIFICATION:
 - 1-1.HOUSING: LCP UL94V-0
 - 1-2.SHELL: C2680 T=0.2mm
 - 1-3.CONTACT: C5191 T=0.25mm
 - 2.PLATING SPECIFICATION:
 - Au PLATING ON CONTACT AREA
 - TIN PLATING ON SOLDER AREA
 - NI PLATING ALL AREA
 - 2-1.SHELL: Ni PLATING OVER ALL
 - 2-2.LED: TIN PLATING OVER ALL
 - 3.MECHANICAL PERFORMANCE:
 - 3-1.INSERTION FORCE: 22N MAX
 - 3-2.REMOVAL FORCE: 22N MAX
 - 3-2.DURABILITY: 750 CYCLES MIN.
 - 4.ELECTRICAL PERFORMANCE:
 - 4-1.CURRENT RATING:1.5A
 - 4-2.VOLTAGE RATING:125V MAX
 - 4-3.CONTACT RESISTANCE: 40mΩ Max.
 - 4-4.INSULATION RESISTANCE: 500MΩ MIN
 - 4-5.DIELECTRIC WITHSTANDING VOLTAGE: 500V AC Min
 - 5.ENVIRONMENTAL PERFORMANCE:
 - OPERATING TEMPERATURE: -40°C~+85°C.
 - 6.PACKAGE SPEC:TRAY

P/N:
WLR4F9-08 8 X X X 033

- PLATING:
- 1-G/F
 - 2-Au 3u"
 - 3-Au 6u"
 - 5-Au 15u"
 - 6-Au 30u"
- LED:
- 1-LEFT:YELLOW
 - RIGHT:GREEN
 - 2-LEFT:GREEN
 - RIGHT:YELLOW
- COLOUR:
- A-BLACK
 - E-YELLOW

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO: WLR4F9-088XXX033	DWG.NO: ENDE05	 WanLian Technology Co., Ltd	
A0	NEW RELEASE	21.01.13		LINEAR	ANGLES	APPROVED	Wang_jr	21.01.13				
				0.0±0.35	X°REF±6°							
			UNIT:mm	0.00±0.25	X°±3°	DESIGNER	Han_Gao	21.01.13	TITLE: RJ45 8P8C DIP沉板式8.8MM		REV: A0	SHEET: 1/1
			SIZE: A4	0.000±0.10	X°X' ±2°	DRAWN	Zijun_Huang	21.01.13				